## CRMKGL1010B

#### N-Channel 100V, 9.2mΩ Typ. Power MOSFET

### **Description**

#### **Features**

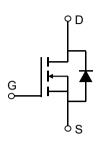
• 100V, 60A

$$R_{DS(ON)}$$
 Typ = 9.2m $\Omega$  @  $V_{GS}$  = 10V  
 $R_{DS(ON)}$  Typ = 11.6m $\Omega$  @  $V_{GS}$  = 4.5V

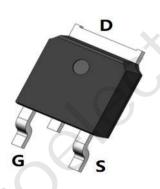
- Advanced Split Gate Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

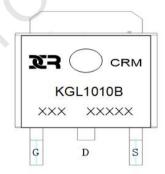
## **Application**

- Load Switch
- PWM Application
- Power Management









**Marking and Pin Assignment** 

## **Package Marking and Ordering Information**

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKGL1010B	CRMKGL1010B	TO-252-3L	TAPING	13"	2500	25000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		100	V
$V_{GS}$	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T <sub>C</sub> = 25°C	60	Α
I <sub>D</sub>	Continuous Drain Current	T <sub>C</sub> = 100°C	36	Α
I <sub>DM</sub>	Pulsed Drain Current <sup>(1)</sup>		240	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (2)		76	mJ
$P_{D}$	Power Dissipation	T <sub>C</sub> = 25°C	78	W
$R_{ hetaJC}$	Thermal Resistance, Junction to Case		1.6	°C/W
$T_{J}, T_{STG}$	Junction & Storage Temperature Range		-55 to 150	°C

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### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
	acteristics			71		
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 100V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
	acteristics				G	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	1.6	2.4	V
_		V <sub>GS</sub> = 10V, I <sub>D</sub> = 30A	-	9.2	12	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 4.5V, I_D = 20A$	-	11.6	15.1	mΩ
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			1098	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 50V,$ f = 1MHz	Χ-\	413	-	pF
$C_{rss}$	Reverse Transfer Capacitance	1 - 11VII 12		5	-	pF
$Q_g$	Total Gate Charge		<b>U</b> -	27	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 50V, I_{D} = 12A$	<i>-</i>	3.5	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 12A	-	6.2	-	nC
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime	.( )	-	12.3	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 50V$	-	10	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D$ = 12A, $R_{GEN}$ = $3\Omega$	-	28	-	ns
$t_{\rm f}$	Turn-Off Fall Time		-	13	-	ns
Drain-So	urce Diode Characteristics and I	Max Ratings				
I <sub>S</sub>	Maximum Continuous Drain to Source D	iode Forward Current	-	-	60	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	240	Α
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 20A$	_	_	1.2	V

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $E_{AS}$  condition: Starting  $T_J$ =25°C,  $V_{DD}$ =50V,  $V_G$ =10V,  $R_G$ =25ohm, L=0.5mH,  $I_{AS}$ =17.5A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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### **Test Circuit**

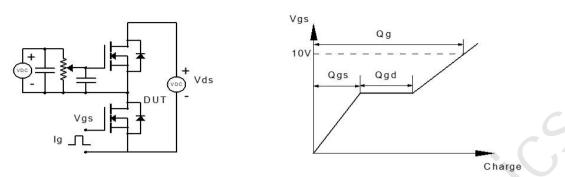


Figure 1: Gate Charge Test Circuit & Waveform

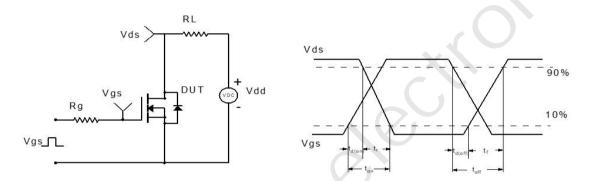


Figure 2: Resistive Switching Test Circuit & Waveform

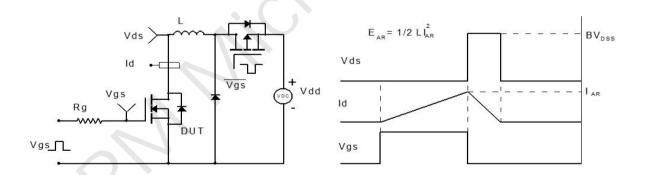


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

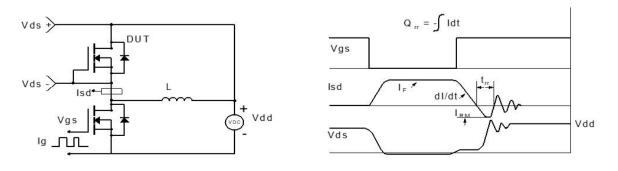
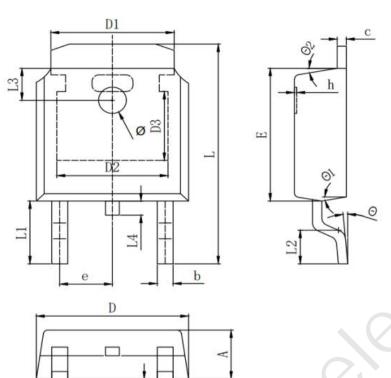


Figure 4: Diode Recovery Test Circuit & Waveform

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## Package Mechanical Data(TO-252-3L)



SYMBOL	MILLIMETER				
SIMBOL	MIN	Тур.	MAX		
A	2.200	2.300	2.400		
A1	0.000		0. 127		
b	0.640	0.690	0.740		
(电镀后)	0.460	0.520	0.580		
D	6.500	6.600	6, 700		
D1	5. 334 REF				
D2	4. 826 REF				
D3	3. 166 REF				
Е	6.000	6. 100	6. 200		
e	2. 286 TYP				
h	0.000	0.100	0. 200		
L	9, 900	10.100	10.300		
L1	2. 888 REF				
L2	1.400	1.550	1.700		
L3	1.600 REF				
L4	0.600	0.800	1.000		
ф	1.100	1.200	1. 300		
θ	0°		8°		
θ 1	9° TYP				
θ2	9° TYP				

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### **Contact information**

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